



May 18, 2009

To: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:	Serial No. 10/786,807	Feb. 25, 2004
	H. M. CHEN ET AL.	
	"METHOD FOR IMPROVING SEMICONDUCTOR WAFER TEST ACCURACY"	
	Grp. Art Unit: 2822	AU, BAC H

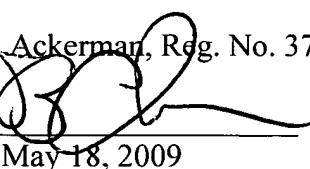
RESPONSE TO FINAL OFFICE ACTION

Dear Sir:

In response to the Final Office Action mailed Feb. 18, 2009, please amend the above-identified application for patent and consider the remarks, as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 18, 2009.

Stephen B. Ackerman, Reg. No. 37,761
Signature 
Date May 18, 2009

Amendments to the Claims are reflected in the listing of the Claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 7 of this paper.